



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT
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TECHNOLOGY CENTER 2800

In re Application of:

Vernon M. Williams

Serial No.: 09/511,986

Filed: February 24, 2000

For: STEREOLITHOGRAPHICALLY
FABRICATED CONDUCTIVE
ELEMENTS, SEMICONDUCTOR DEVICE
COMPONENTS AND ASSEMBLIES
INCLUDING SUCH CONDUCTIVE
ELEMENTS, AND METHODS

Confirmation No.: 6129

Examiner: O. Nadav

Group Art Unit: 2811

Attorney Docket No.: 4208US
(99-0316.00/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

May 5, 2003
Date

Signature

Deidra Pfeil
Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO/SB/08A be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a). The listed documents were cited by the Office in co-pending application

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Serial No. 10/109,366, filed on March 28, 2002, and in co-pending application Serial No. 10/274,907, filed on October 21, 2002, and directed to related inventions.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicant herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

<u>U.S. Patent Documents</u>		
<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 6,063,641	05/16/2000	Seki
US - 6,468,891 B2	10/22/2002	Williams

Applicant offers to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits.

Serial No. 09/511,986

The fee pursuant to 37 C.F.R. § 1.17(p) is enclosed.

Respectfully submitted,



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Date: May 5, 2003
BGP/jml

Enclosures: Form PTO/SB/08A
Copy of documents cited
Check No. 4235 in the amount of \$180.00

Document in ProLaw